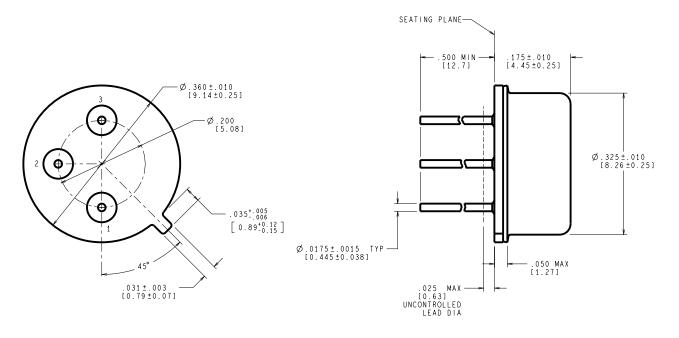
REVISIONS									
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D					
С	REVISE & REDRAW PER NEW STANDARD	10403	05/24/94	TL/GM					
D	UPDATE MILAERO STAMP; Ø.325 WAS Ø.326; REVISE TOLERANCES	10798	02/28/95	TL/					



CONTROLLING DIMENSION IS INCHVALUES IN [] ARE MILLIMETERS

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. LEADS TO BE LOCATED WITHIN .010 IN/ 0.25 mm OF THEIR TRUE POSITIONS RELATIVE TO A MAXIMUM WIDTH TAB.
- 2. STANDARD METAL CAN TYPE: SOLID BASE, KOVAR.
- 3. APPLIES TO MIL-AERO AND LINEAR PRODUCTS.
- 4. REFERENCE JEDEC REGISTRATION TO-39, JEDEC PUBLICATION No. 95.

MIL-I-38535 CONFIGURATION CONTROL

APPROVALS	DATE	▲ National Semiconductor				
T. LEQUANG	2900 Semiconductor dr. Santa Clara, CA 95052-8090					
DFTG. CHK.	METAL CAN, TO-39, 3 LEAD,					
ENGR. CHK.						
		.200 DIA P.C.				
PROJECTIO		SCALE	SIZE	DRAWING NUMBER		REV
◎ ∈		N/A	C	MK1	-H03A	D
INCH [MM]		DO NOT S	SCALE	DRAWING	SHEET 1 of	1